

9mm Diameter Water-proof with Round Terminals (Radial Type)



A round terminal type with highly efficient PC board mouting with excellent dust-proof and water-proof performance.



Typical Specifications

Турісаї оросінсаціоно				
Items	Specifications			
Rating (max.)	50mA 12V DC			
Rating (min.)	10μA 1V DC			
Initial contact resistance	500mΩ max.			
Travel (mm)	0.25			

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line

Package Type
TACT Switch™

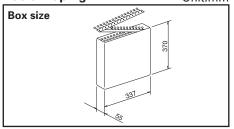
Product Line

I	Product No.	Operating force	Operating direction	Operating life	Stem color	Minimum order unit (pcs.)		
ı	Product No.	Operating force	Operating direction	(5mA 5V DC)	Stelli color	Japan	Export	
	SKRCACD010	1.57N	Tannuah	Tonnuch 100 000 oveles	Dark gray	900	900	
I	SKRCADD010	2.55N	Toppush	100,000cycles	Red	900	900	

Packing Specifications

Radial Taping





Num	Export package		
1 box	1 case / Japan	1 case / export packing	measurements (mm)
900	9,000	9,000	353 × 764 × 309

Style PC board mounting hole dimensions (Viewed from switch mounting face)

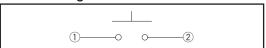
Sharp Feeling

Soft Feeling Snap-in Type

Surface Mount Type

Radial Type

Circuit Diagram



Water Resisting Performance

Temperature of water	60℃
Depth of water	10cm
Immersion duration	240h

Notes

- 1. Please use 1.6mm thick PC boards.
- 2. When the switch is used in an environment subject to high humidity or condensation, make sure the terminals are coated thoroughly to prevent current leakage between terminals.

ALPS

- 3. Avoid using coating material containing toluene or xylene. For more information on coating material, please contact us.
- 4. Switch terminals must be coated thoroughly until the terminals are fully covered.

TACT Switch™

List of Varieties

Detector Push Slide **Rotary Encoders** Power Dual-in-line Package Type TACT Switch™

Sharp Feeling Soft **Feeling** Snap-in

Type Surface **Mount Type**

Radial Type

Time			p Feeling	Туре				Soft Fee	ling Type			
	Туре		Radial			Snap-in		Su	rface Mo	unt	Rad	dial
	Series	SKRG	SKGK	SKRC	SKEG	SKEG	SKPF	SKPM	SKPG	SKPR	SKPL	SKPD
	Photo		***	888								
	Features	Round terminal type	_	Round terminal type	_	_	High operation force and long travel	Low contact resistance	_	High operation force and Low contact resistance	Round terminal and low contact resistance	_
w	ater-proof	_	_	•	_	_	_	_	_	_	_	_
D	ust-proof	_	_	•	_	_	_	_	_	_	_	_
Operatin	Toppush	•	•	•	•	_	•	•	•	•	•	•
direction	Sidepush	_	_	_	_	•	_	_	_	_	_	_
	W	φ6.2	□ 6.6	<i>φ</i> 9	□6	7.5	8	5.9	6.6	7.5	φ6.45	□7.8
Dimension (mm)	ns D	φ0.2	0.0	φθ		9.9	9	6	6.3	7.8	φ0.43	
. ,	Н	4.3	5	13	7	7.3	10	ţ	5	6.5	5	5
1	Contact		_	_		Carbon		Silver	Carbon	Silver	Car	bon
Operatio force	2N~3N	1	1	1	Ţ	1	1	1	1		1	1
coverage	9 3N~4N 4N~5N						+			\$		
Т	ravel (mm)		0.25			1	% 1	1.	.3	1	1.3	% 1
Gro	und terminal	_	_	_	_	_	_	_	_	_	_	_
Operati	ng temperature range	-40°C to +90°C	-20°C to +70°C	- 40°C to + 90°C	-20°C to	+70°C			-40°C to	o +90°C		
Auto	omotive use	•	_	_	_	_	•	•	•	•	•	•
L	ife Cycle	* 2	* 2	* 2	* 2	* 2	* 2	*3	*3	*3	* 2	* 2
	Rating (max.) (Resistive load)	50)mA 12V [oc	5mA 12V DC					5mA 12V DC		
Electrical	Rating (min.) (Resistive load)	1	0 μ A 1V D	С				10 μ A	1V DC			
performance	Insulation resistance	100M	Ω min. 100 for 1min.	V DC	100MΩ min. 100V DC for 1min.							
	Voltage proof	250	V AC for 1	min.			250	V AC for 1	min.			% 2
Durchility	Vibration	10 to 55 to 10H for all the fred X, Y and	tz/min., the ampl quencies, in the Z for 2hours res	litude is 1.5mm 3 direction of spectively	10 to 55	to 10Hz/n in the 3 dir	nin., the am ection of X,	plitude is 1 Y and Z fo	1.5mm for a or 2hours r	all the frequespectively	iencies,	% 3
Durability -	Lifetime	Shall be	in accorda ual specific	nce with		Shall be in accordance with individual specifications.						
	Cold	-40±2°C for 96h	-30±2℃ for 96h	-40±2°C for 96h	- 30±2°	C for 96h	-40±2°C for 96h	- 30	0±2°C for	96h	-40 ± 2°C for 1000h	$-40 \pm 2^{\circ}\text{C}$ for 96h
Environmental performance	Dry heat	90±2℃ for 96h	80±2℃ for 96h	90±2℃ for 96h	80±2℃	for 96h	90 ± 2°C for 96h	80	±2°C for 9	06h	90 ± 2°C for 1000h	90 ± 2°C for 96h
	Damp heat	60± 90 to 95%	2℃ , RH for 96h	60 ± 2°C, 90 to 95%RH for 1000h		60±	2℃ , 90 to	95%RH fo	r 96h		60 ± 2°C , 90 to 95%RH for 1000h	60 ± 2°C, 90 to 95%RH for 96h
	Page	277	278	279	280	280	282	283	284	285	286	287
						10/ - 10	lidth Tha	most suts	r dimonoid	an ovoludii	ag tarming	l portion.

W: Width. The most outer dimension excluding terminal portion. D: Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

 TACT Switch[™] Soldering Conditions
 TACT Switch[™] Cautions 289

- 1. The automotive operating temperature range to be individually discussed upon request.

- Indicates applicability to all products in the series.
 ※ 1 See the relevant pages for respective product descriptions
 ※ 2 50MΩ min. 100V DC for 1min. SKPDAF:100MΩmin. 100V DC for 1min.
 ※ 3 100V AC for 1min.SKPDAF:250V DC for 1min.

TACT Switch™ Soldering Conditions

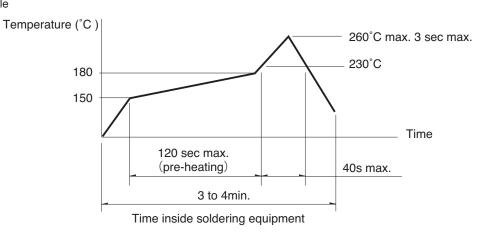
Condition for Reflow

Available for Surface Mount Type.

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2 ϕ CA (K) or CC (T) at solder joints (copper foil surface) .

A heat resistive tape should be used to fix thermocouple.

3. Temperature profile



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Slide

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Dual-in-line Package Type

TACT Switch™

Sharp Feeling Soft

Feeling Snap-in Type Surface Mount Type

Radial Type

Notes

- 1. The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip Available for Snap-in Type and Radial Type

Items	Condition
Flux built-up	Mounting surface should not be exposed to fluk
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH、SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to fluk
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKOJ. SKOK. SKEG Series

ShQJ, ShQh, ShEG Series				
Items	Condition			
Flux built-up	Mounting surface should not be exposed to fluk			
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.			
Preheating time	45s max.			
Soldering temperature	255℃ max.			
Duration of immersion	5s max.			
Number of soldering	2times max.			

Manual Soldering (Except SKRT Series)

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH、SKHW、SKRG、SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKQJ、SKQK、SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Consult with us for availability of TACT Switch[™] washing.
- 2. Prevent flux penetration from the top side of the TACT Switch $^{\text{TM}}$.
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- The second soldering should be done after the switch is stable with normal temperature.
- 5. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA Corporation, or equivalents.)